B36J3RGB-F6C0001HOU1930

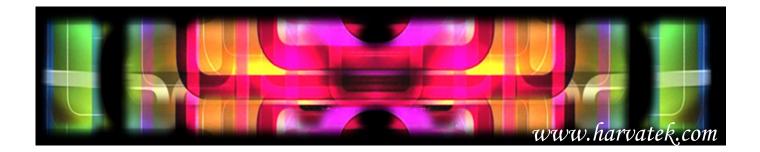


Features

- •Package: RGB 3 in 1 package/4pin Polarity
- •Anti-Reflection resin
- •View angle : >=120° (min 50% brightness)
- •Component solder able surface finish is gold
- •High contrast

Main Applications

- Indoor display
- •Full color display
- •Fine pitch application



Top Mount RGB Chip LED B36J3RGB-F6C0001HOU1930

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DISCLAIMER

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HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

	Specification	Material	Quantity
Luminous	Red : 32 mcd typical		
Intensity(Iv)	Green : 46 mcd typical		
	Blue : 8 mcd typical		
	R@5mA;G/B@2mA/ Ts= 25 ⁰ C; Tolerance ±10%		
Wavelength	Red : 621 nm typical		
	Green: 530 nm typical		
	Blue : 470 nm typical		
	R@5mA;G/B@2mA/ Ts= 25 ⁰ C;Tolerance ± 0.5nm		
Vf	Red : 2.4 V maximum		
	Green:3.1 V maximum		
	Blue : 3.1 V maximum		
	R@5mA;G/B@2mA/ Ts= 25° C;Tolerance ± 0.05V		
Ir	< =1 µA @ V _R = 5 V		
Resin	Dark	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	24000pcs/reel
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

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Others:

Each immediate box consists of 28 reels. The 28 reels may not necessarily have the same lot number or the same bin

combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note : This is shipped test conditions

%Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

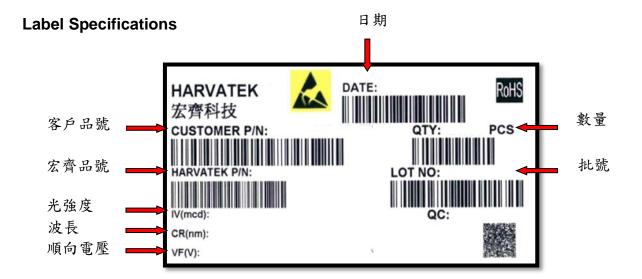
ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be

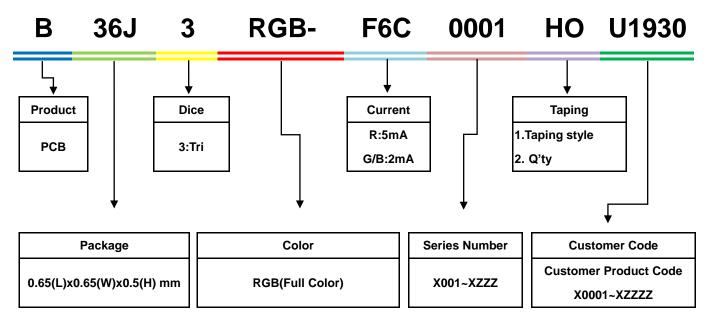
taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.



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Harvatek P/N:



■ Lot No.

1	2	3	4	5	6	7	8	9	10
1	7	Ν	Е	4	1	L	Ν	1	1
Cod	e 1 2	Code 3	Code 4	Code 5	Code 6	Code 6 Code 7		Code 9	Code 10
			Mfg.Year	Mfg.Month	Consecutiv	ve number	9,	Special code	5
Internal Tr	acing Code	Mixing Lot No.	2010-A 2011-B 2012-C 2013-D 2014-E	1:Jan 2:Feb A:Oct B:Nov C:Dec	01	~ZZ		000~ZZZ	

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Specifications Range

Luminous Intensity (Iv) Bin:

Luminous Intensity (Iv) Bin: R@5mA;G/B @2mA

	B36J3RGB Series										
	IV										
	Red			Green			Blue				
HF3	21.3	26.7	HG3	30	37.5	HB3	5.4	6.8			
HG1	24	30	HH1	33.5	42	HC1	6	7.5			
HG2	26.7	33.5	HH2	37.5	47	HC2	6.8	8.5			
HG3	30	37.5	HH3	42	52.5	HC3	7.5	9.4			
HH1	33.5	42	HJ1	47	60	HD1	8.5	10.7			
HH2	37.5	47	HJ2	52.5	65.7	HD2	9.4	12			
HH3	42	52.5	HJ3	60	75	HD3	10.7	13.4			

Note: It maintains a tolerance of ±10% on Luminous Intensity

Dominant Wavelength (λ_D) Bin: R@5mA;G/B @2mA

	B36J3RGB Series										
	WD										
Red Green Blue											
RH2	618	623	GH1	526	530	BH1	464	468			
RH3	623	628	GH2	528	532	BH2	466	470			
RH4	628	633	GH3	530	534	BH3	468	472			
			GH4	532	536	BH4	470	474			
			GH5	534	538						

Note: It maintains a tolerance of ±0.5nm on Color Bin

Forward Voltage (Vf) Bin: R@5mA;G/B @2mA

	B36J3RGB Series									
Vf										
	Red		Green			Blue				
E18	1.6	2.4	F2A	2.1	3.1	F2A	2.1	3.1		

Note: It maintains a tolerance of ±0.05V on forward voltage measurements

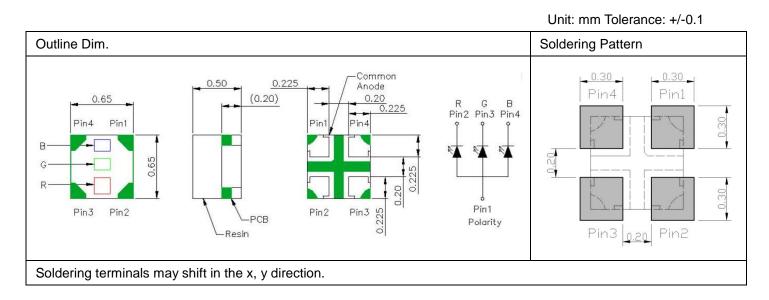
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Product Features

Electro-Optical Characteristics

(I _F Red@5mA,Green &Blue@2mA, T _s 25 °C)								A, T _s 25 °C)
Part number	Emitting Color		ward ge(VF)	Wavelength (nm) typ.		l [*] _v (mcd)	Viewing	
		typ.	max.	λD	λр	Δλ	typ.	Angle 201/2
B36J3RGB-F6C0001HOU1930	Ultra Bright Red	1.9	2.4	621	628	11	32	140
	Green	2.5	3.1	530	521	28	46	140
	Blue	2.5	3.1	469	465	16	8	140

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering



Absolute Maximum Ratings							
						(T _S 25 °C)	
Series	P _D (mW)	I _F (mA)	I _{FP} (mA)	Vr(V)	T _{OP} (^o C)	T _{ST} (°C)	
Color	Power Forward Current			Operation	Storage		
Color	Dissipation	Forward Current	Pulse Forward Current	Reverse Voltage	Temperature	Temperature	
Red	24.4	5	20	F	20 190	40.95	
Blue/Green	24.4	2	20	5	-30~+80	-40~85	

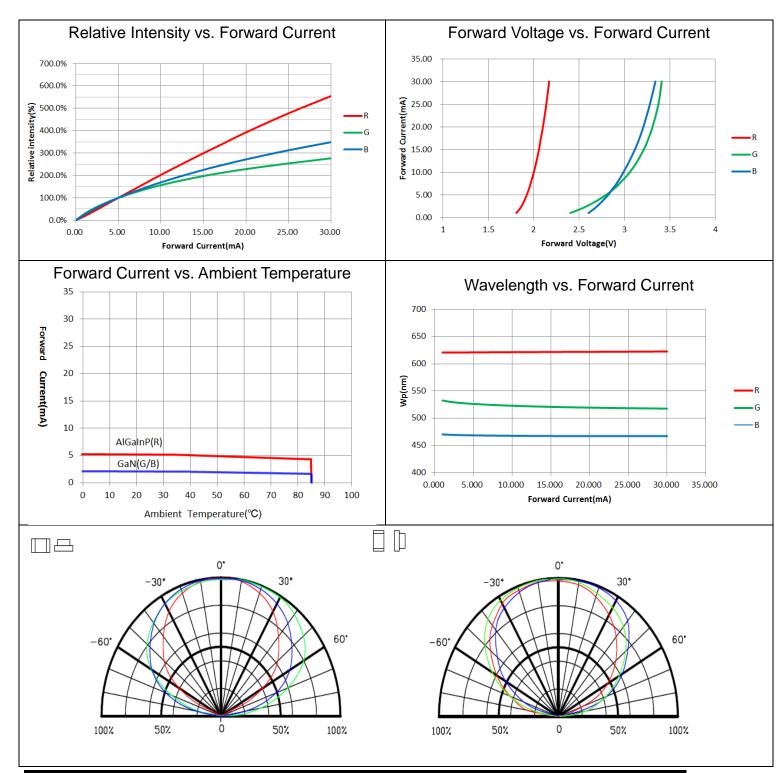
** Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

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Characteristics of B36J3RGB-F6



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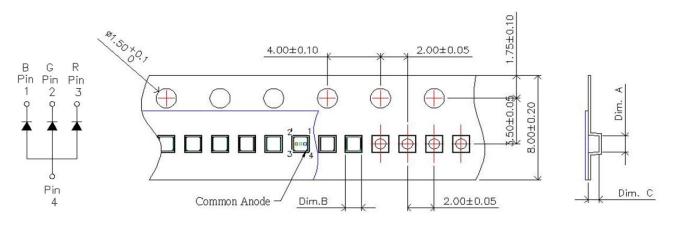
Precaution for Use

- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within seven days after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

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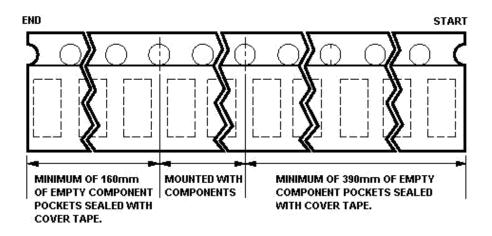
Top Mount RGB Chip LED B36J3RGB-F6C0001HOU1930

Packaging Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
0.72±0.03	0.72±0.03	0.56±0.03	24K
nit: mm			

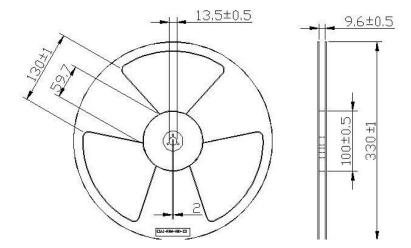
nit: mm



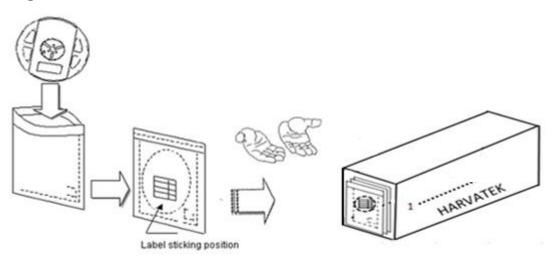
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Reel Dimension



Packing



28 boxes per carton is available depending on shipment quantity.

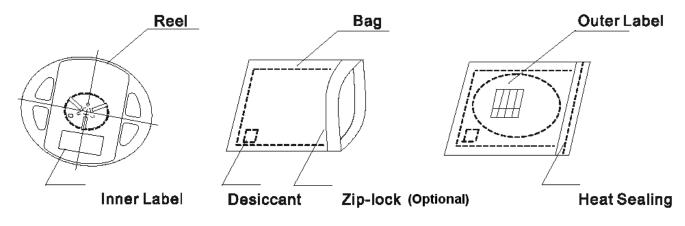
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4weeks. The conditions are as followings:

- 1. MBB open≤672hrs, 50±3°C×(3hrs)
- 2. MBB open>672hrs, $60\pm3^{\circ}C\times(8^{-12hrs})$ and $5^{\circ}RH$, taped reel type.
- 3. 100±3℃×(45min~1hr), bulk type.(散裝)
- 4. 130±3℃×(15min~30min), bulk type.(散裝)

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PRECAUTIONS

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

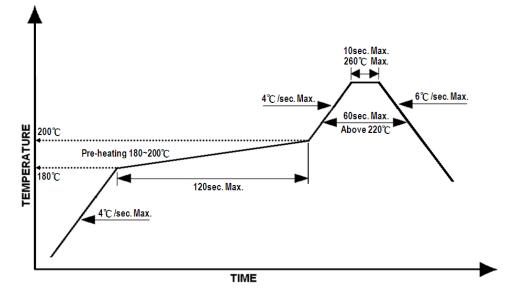
Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 220 ^OC ,60sec
- 2. Peak temp.:260 ^OCMax.,10sec Max.
- 3. Never take next process until the component is cooled down to room temperature after reflow.
- 4. The recommended reflow soldering profile (measuring on the surface of the LED terminal) is following:

Lead-free Solder Profile

5. Reflow soldering should not be done more than two times



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Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 ^OC max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

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Revise History

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